FAIRCHILD

SEMICONDUCTOR®

FDMC86520L N-Channel Power Trench[®] MOSFET 60 V, 22 A, 7.9 m Ω

Features

- Max $r_{DS(on)}$ = 7.9 m Ω at V_{GS} = 10 V, I_D = 13.5 A
- Max $r_{DS(on)}$ = 11.7 m Ω at V_{GS} = 4.5 V, I_D = 11.5 A
- Low Profile 1 mm max in Power 33
- 100% UIL Tested
- RoHS Compliant

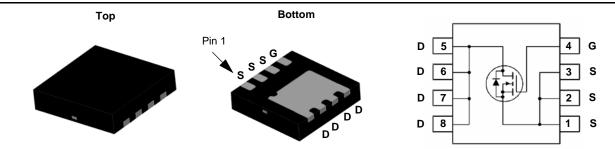


General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$, fast switching speed and body diode reverse recovery performance.

Applications

- Primary Switch in isolated DC-DC
- Synchronous Rectifier
- Load Switch



MLP 3.3x3.3

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			60	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous (Package limited)	T _C = 25 °C		22		
	-Continuous (Silicon limited)	T _C = 25 °C		55	^	
I _D	-Continuous	T _A = 25 °C	(Note 1a)	13.5	A	
	-Pulsed			60		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	79	mJ	
P _D	Power Dissipation	T _C = 25 °C		40	W	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.3	v	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.1	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	53	C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC86520L	FDMC86520L	Power 33	13 "	12 mm	3000 units

August 2011

FDMC86520L
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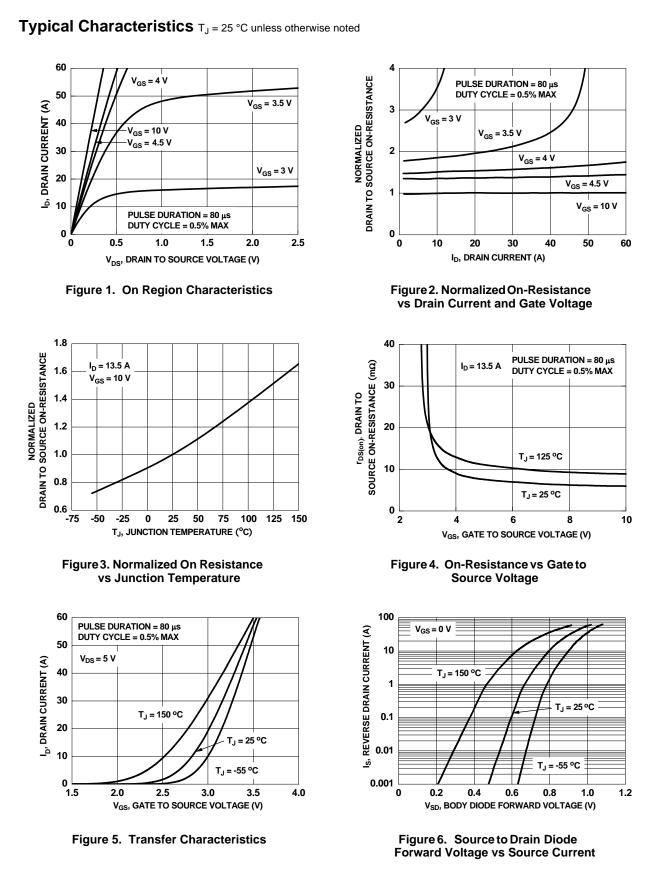
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	60			V
ΔBV _{DSS} ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		29		mV/°C
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 48 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1	1.7	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-7		mV/°C
5		V _{GS} = 10 V, I _D = 13.5 A		6.5	7.9	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 11.5 \text{ A}$	9.1 11.7		mΩ	
20(01)		V _{GS} = 10 V, I _D = 13.5 A, T _J = 125 °C		9	11	-
9 _{FS}	Forward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 13.5 \text{ A}$		49		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance			3420	4550	pF
C _{OSS}	Output Capacitance	$V_{\rm DS} = 30 \text{ V}, V_{\rm GS} = 0 \text{ V},$		638	850	pF
Crss	Reverse Transfer Capacitance	f = 1 MHz		25	40	pF
R _g	Gate Resistance			0.5		Ω
	g Characteristics				I	
t _{d(on)}	Turn-On Delay Time			15	30	ns
t _r	Rise Time	V _{DD} = 30 V, I _D = 13.5 A,		5.2	10	ns
d(off)	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		32	55	ns
d(UII)	Fall Time			3.4	10	ns
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		45	64	nC
$Q_{g(TOT)}$	Total Gate Charge			21	30	nC
Q_{gs}	Total Gate Charge	$I_{\rm D} = 13.5 \text{ A}$		9.6		nC
Q _{gd}	Gate to Drain "Miller" Charge	-		4.9		nC
	urce Diode Characteristics	/				1
		$V_{GS} = 0 V, I_S = 13.5 A$ (Note 2)		0.82 1.3		
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.71	1.2	V
rr	Reverse Recovery Time			38	62	ns
Q _{rr}	Reverse Recovery Charge	— I _F = 13.5 A, di/dt = 100 A/μs		21	34	nC
IOTES:	nined with the device mounted on a 1 in ² pad 2 oz copper part rd design.	ad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is gu	iaranteed b	y design while	e R _{θCA} is de	termined by
	53 °C/W when mou 1 in ² pad of 2 oz co			/ when moun n pad of 2 oz		



2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

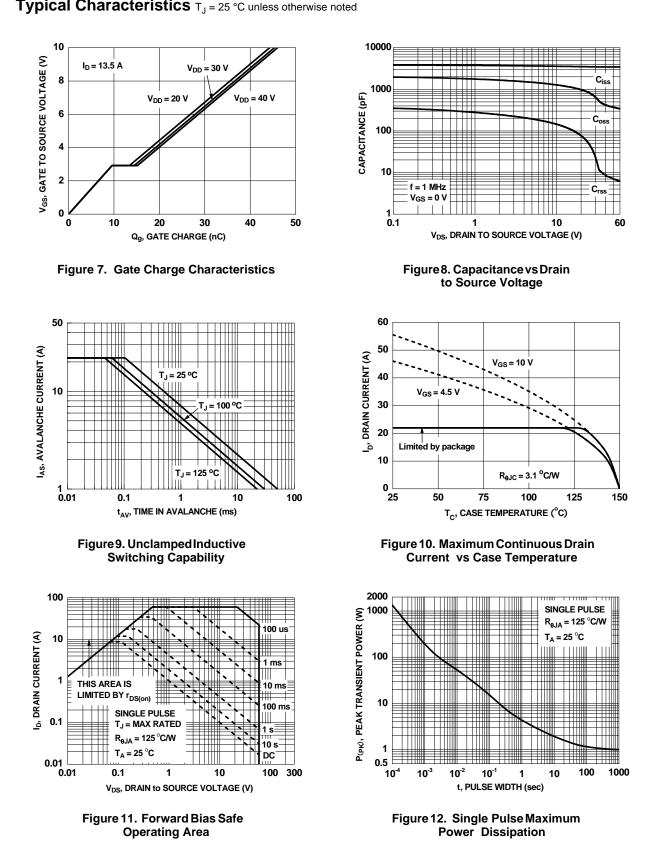
3. Starting T_J = 25 °C; N-ch: L = 0.3 mH, I_{AS} = 23 A, V_{DD} = 54 V, V_{GS} = 10 V.

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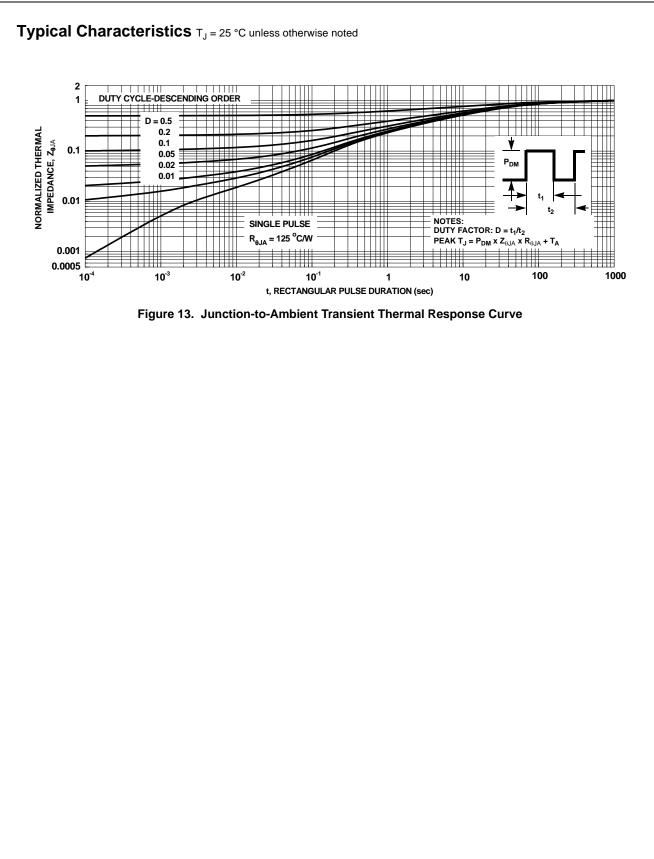
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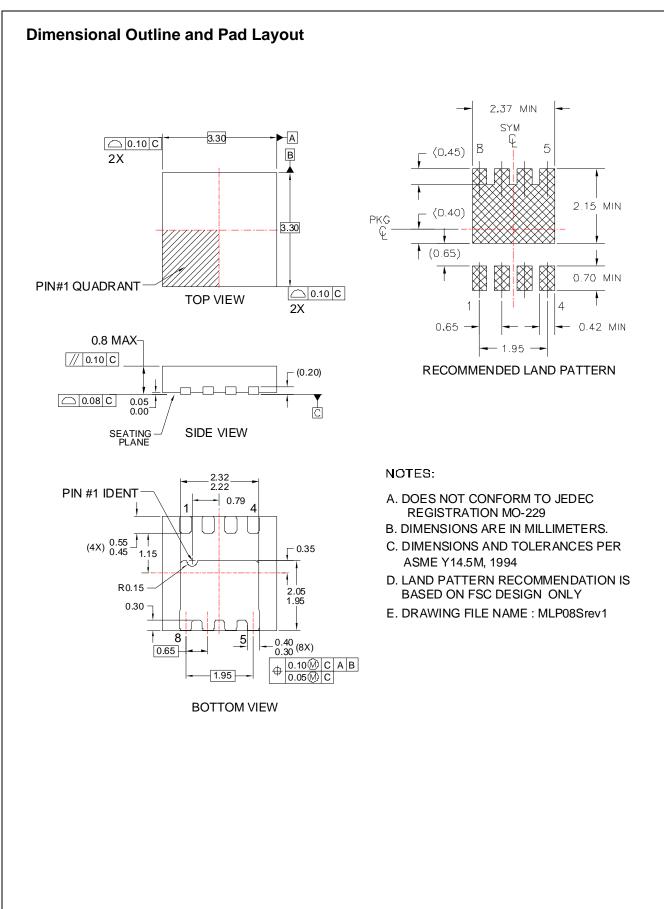
Typical Characteristics T_J = 25 °C unless otherwise noted

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FDMC86520L N-Channel PowerTrench[®] MOSFET

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